ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES International and P	IPC. Bannockt	ourn. Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declaratio he declaration en	n of the substand compasses all lo	es within the manufactur wer level materials for w	rer listed ite hich the ma	m. Note: if nufacturer	the item is an as has engineering	sembly with low responsibility.	
	21.1 IPC Web Site for Information on IPC-1752 Standard For http://www.ipc.org/IPC-175x Dis				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information													
Company name* Company			any unique ID			Unique ID Authority				Response Date*			
onsemi										2025-05-09			
Contact Name Title - Contact			ct	Phone		Phone - Contact	e - Contact*			Email - Contact*			
Product-Env-Stewards Product Envir			Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represent			sentative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product Envir			Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		'eight*	UOM	Unit Type	
	FSB5055	B50550AS SPM5 V2 INV 500		0V 1.40hm		2025-05-09 CPA		СРА	33	355.2	mg	Each	
Anufacturing Proccess Inform	ation					·							
Terminal Plating / Grid Array M	rminal Plating / Grid Array Material Terminal Base A		Alloy J	-STD-020 MSL	Rating	Peak Proces	s Body Tempera	ture Max Time at Peak	Temperatu	re Numbe	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy			3			260	С	30	second	s <b>3</b>			
omments													
<b>FTENTION: MSL 3 Rated item requir</b>	es Bake and D	ry Pack (after	electrical test)										
or more information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company that agreement, will be the sole and exclusive	lease indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, dmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part ontains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall accompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. ompany acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not dependently verified information provided by others, Supplier agrees that, at a minimum, itsuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the errification in this paragraph. If the Company and the Supplier ent into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of at agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in th									
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).							
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the					
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	24.0	mg	Supplier	Silicon (Si)	7440-21-3		24	mg
Die Attach	6.0	mg	Supplier	Silver (Ag)	7440-22-4		4.56	mg
			Supplier	Phenolic Resin-2	54208-63-8		1.44	mg
Die Attach Solder	4.8	mg	Supplier	Silver (Ag)	7440-22-4		0.12	mg
			А	Lead (Pb)	7439-92-1	7a	4.44	mg
			Supplier	Tin (Sn)	7440-31-5		0.24	mg
Lead Frame	1370.0	mg	Supplier	Silver (Ag)	7440-22-4		20.002	mg
			В	Nickel (Ni)	7440-02-0		30.003	mg
			Supplier	Iron (Fe)	7439-89-6		1.37	mg
			Supplier	Copper (Cu)	7440-50-8		1318.214	mg
			Supplier	Phosphorus (P)	7723-14-0		0.411	mg
Mold Compound-Black	1890.0	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		132.3	mg
			Supplier	Carbon Black (C)	1333-86-4		18.9	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		661.5	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		132.3	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		945	mg
Plating	56.4	mg	Supplier	Tin (Sn)	7440-31-5		56.4	mg
Wire Bond - Cu	4.0	mg	Supplier	Palladium (Pd)	7440-05-3		0.08	mg
			Supplier	Copper (Cu)	7440-50-8		3.92	mg